

## ST13003

# HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- MEDIUM VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED

#### **APPLICATIONS:**

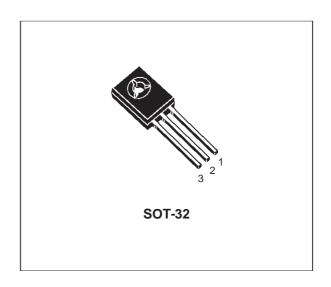
- ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING
- SWITCH MODE POWER SUPPLIES

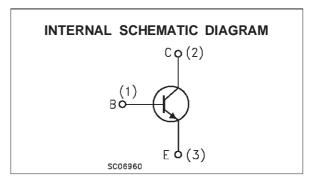
#### **DESCRIPTION**

The device is manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds and medium voltage capability.

It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA.

The device is designed for use in lighting applications and low cost switch-mode power supplies.





#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-Emitter Voltage (V <sub>BE</sub> = 0)	700	V
V <sub>CEO</sub>	Collector-Emitter Voltage (I <sub>B</sub> = 0)	400	V
$V_{EBO}$	Emitter-Base Voltage (I <sub>C</sub> = 0)	9	V
Ic	Collector Current	1.5	Α
I <sub>CM</sub>	Collector Peak Current (t <sub>p</sub> < 5 ms)	3	А
I <sub>B</sub>	Base Current	0.75	Α
I <sub>BM</sub>	Base Peak Current (t <sub>p</sub> < 5 ms)	1.5	А
P <sub>tot</sub>	Total Dissipation at T <sub>c</sub> = 25 °C	40	W
T <sub>stg</sub>	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

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#### THERMAL DATA

R <sub>thj-case</sub>	Thermal Resistance Junction-case	Max	3.12	°C/W
R <sub>thj-a</sub>	Thermal Resistance Junction-ambient	Max	89	°C/W

## **ELECTRICAL CHARACTERISTICS** (T<sub>case</sub> = 25 °C unless otherwise specified)

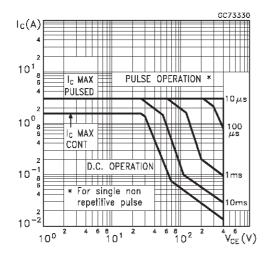
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
I <sub>CEV</sub>	Collector Cut-off Current (V <sub>BE</sub> = -1.5V)	V <sub>CE</sub> = 700V V <sub>CE</sub> = 700V	T <sub>j</sub> = 125°C			1 5	mA mA
I <sub>EBO</sub>	Emitter Cut-off Current (I <sub>C</sub> = 0)	V <sub>EB</sub> = 9 V				1	mA
V <sub>CEO(sus)*</sub>	Collector-Emitter Sustaining Voltage (I <sub>B</sub> = 0)	I <sub>C</sub> = 10 mA L = 25mH		400			V
V <sub>CE(sat)</sub> *	Collector-Emitter Saturation Voltage	I <sub>C</sub> = 0.5 A I <sub>C</sub> = 1 A I <sub>C</sub> = 1.5 A	$I_B = 0.1 A$ $I_B = 0.25 A$ $I_B = 0.5 A$			0.5 1 3	V V V
V <sub>BE(sat)*</sub>	Base-Emitter Saturation Voltage	I <sub>C</sub> = 0.5 A I <sub>C</sub> = 1 A	I <sub>B</sub> = 0.1 A I <sub>B</sub> = 0.25 A			1.0 1.2	V V
h <sub>FE</sub>	DC Current Gain	I <sub>C</sub> = 0.5 A Group A Group B I <sub>C</sub> = 1 A	$V_{CE} = 2 V$ $V_{CE} = 2 V$	8 15 5		20 35 25	
t <sub>r</sub> t <sub>s</sub>	RESISTIVE LOAD Rise Time Storage Time Fall Time	I <sub>C</sub> = 1 A I <sub>B1</sub> = 0.2 A T <sub>p</sub> = 25 μs	$V_{CC} = 125 \text{ V}$ $I_{B2} = -0.2 \text{ A}$			1.0 4.0 0.7	μs μs μs
ts	INDUCTIVE LOAD Storage Time	IC = 1 A V <sub>BE</sub> = -5 V V <sub>clamp</sub> = 300 V	I <sub>B1</sub> = 0.2 A L = 50 mH		0.8		μs

\* Pulsed: Pulse duration = 300µs, duty cycle = 1.5 %

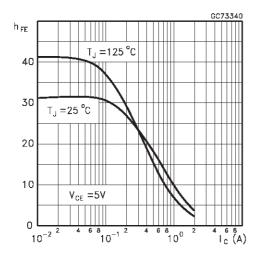
Note: Product is pre-selected in DC current gain (GROUP A and GROUP B). SGS-THOMSON reserves the right to ship either groups according to production availability. Please contact your nearest SGS THOMSON MICROELECTRONICS sales office for delivery details.



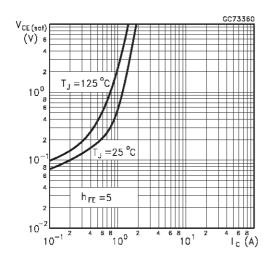
#### Safe Operating Areas



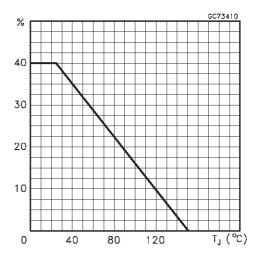
#### DC Current Gain



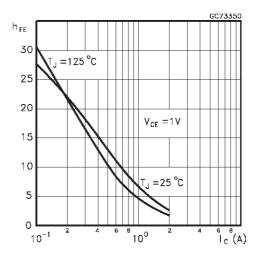
#### Collector Emitter Saturation Voltage



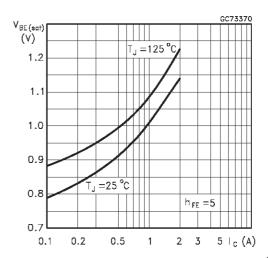
#### **Derating Curve**



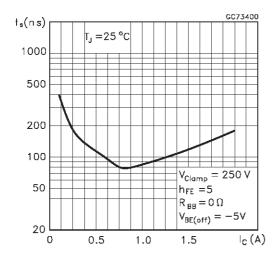
DC Current Gain



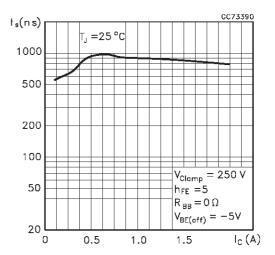
Base Emitter Saturation Voltage



#### Inductive Fall Time



### Inductive Storage Time



#### Reverse Biased SOA

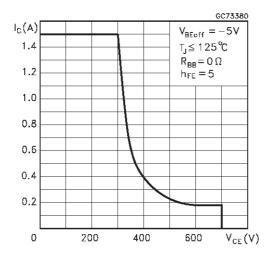


Figure 1: Inductive Load Switching Test Circuits.

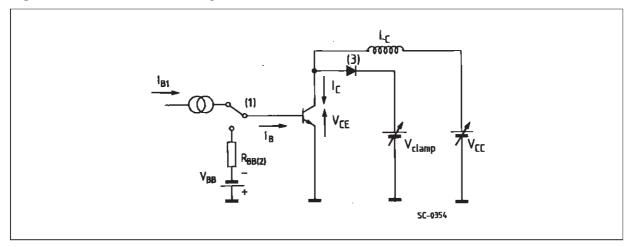
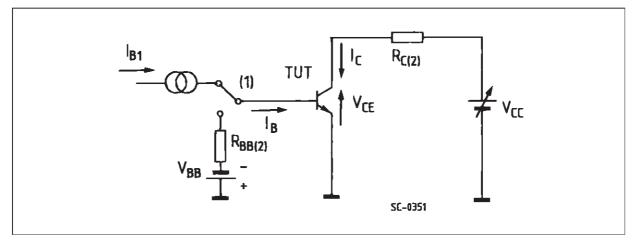
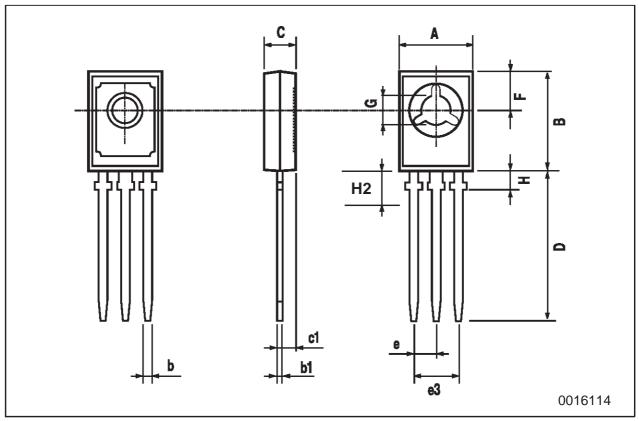


Figure 2: Resistive Load Switching Test Circuits.



# SOT-32 (TO-126) MECHANICAL DATA

DIM.	mm			inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	7.4		7.8	0.291		0.307	
В	10.5		10.8	0.413		0.445	
b	0.7		0.9	0.028		0.035	
b1	0.49		0.75	0.019		0.030	
С	2.4		2.7	0.040		0.106	
c1	1.0		1.3	0.039		0.050	
D	15.4		16.0	0.606		0.629	
е		2.2			0.087		
e3	4.15		4.65	0.163		0.183	
F		3.8			0.150		
G	3		3.2	0.118		0.126	
Н			2.54			0.100	
H2		2.15			0.084		



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